

Product Specification Sheet

100G QSFP28/4SFP28 Direct Attach Cable (DAC) Datasheet

TDQ26X4SP2X-xxx

General Description

QSFP28_4xSFP28 passive copper cable assembly feature eight differential copper pairs, providing four data transmission channels at speeds up to 28Gbps per channel, and meets 100G Ethernet, 25G Ethernet and InfiniBand Enhanced Data Rate (EDR) requirements. Available in a broad range of wire gauges—from 26AWG through 30AWG—this 100G copper cable assembly features low insertion loss and low crosstalk.

Designed for applications in the data center, networking and telecommunications markets that require a high speed, reliable cable assembly, this next generation product shares the same mating interface with QSFP+ form factor, making it backward compatible with existing QSFP ports. QSFP28 can be used with current 10G and 14G applications with substantial signal integrity margin.

Features and Benefits

- Compatible with IEEE 802.3bj, IEEE 802.3by and InfiniBand EDR
- Supports aggregate data rates of 100Gbps
- Optimized construction to minimize insertion loss and cross talk
- Backward compatible with existing QSFP+ connectors and cages
- Pull-to-release slide latch design
- 26AWG through 30AWG cable
- Straight and break out assembly configurations available
- Customized cable braid termination limits EMI radiation
- Customizable EEPROM mapping for cable signature
- RoHS compliant

Product Applications

- Switches, servers and routers
- Data Center networks
- Storage area networks
- High performance computing
- Telecommunication and wireless infrastructure
- Medical diagnostics and networking
- Test and measurement equipment

Industry Standards

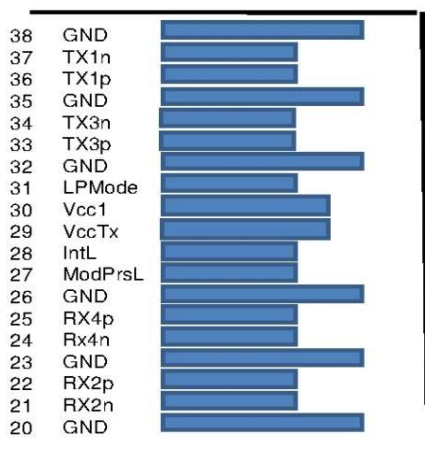
- 100G Ethernet(IEEE 802.3bj)
- 25G Ethernet(IEEE 802.3by)
- InfiniBand EDR
- SFF-8665 QSFP+28GGb/s 4XPluggable Transceiver Solution(QSFP28)
- SFF-8402 SFP+ 1X 28Gb/s Pluggable Transceiver Solution(SFP28)

Pin Descriptions

QSFP28 Pin Function Definition

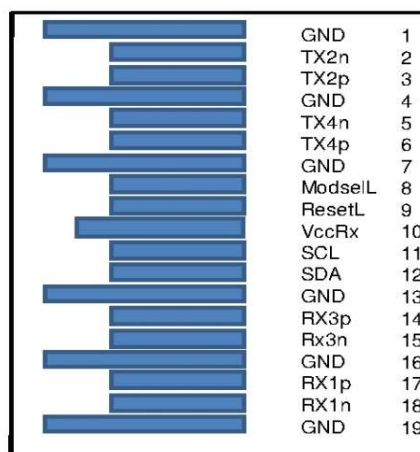
Pin	Logic	Symbol	Description
1		GND	Ground
2	CML-I	Tx2n	Transmitter Inverted Data Input
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input
4		GND	Ground
5	CML-I	Tx4n	Transmitter Inverted Data Input
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input
7		GND	Ground
8	LVTTL-I	ModSelL	Module Select
9	LVTTL-I	ResetL	Module Reset
10		Vcc Rx	+3.3V Power Supply Receiver
11	LVC MOS- I/O	SCL	2-wire serial interface clock
12	LVC MOS- I/O	SDA	2-wire serial interface data
13		GND	Ground
14	CML-O	Rx3p	Receiver Non-Inverted Data Output
15	CML-O	Rx3n	Receiver Inverted Data Output
16		GND	Ground
17	CML-O	Rx1p	Receiver Non-Inverted Data Output
18	CML-O	Rx1n	Receiver Inverted Data Output
19		GND	Ground
20		GND	Ground
21	CML-O	Rx2n	Receiver Inverted Data Output
22	CML-O	Rx2p	Receiver Non-Inverted Data Output
23		GND	Ground
24	CML-O	Rx4n	Receiver Inverted Data Output
25	CML-O	Rx4p	Receiver Non-Inverted Data Output
26		GND	Ground
27	LVTTL-O	ModPrsL	Module Present
28	LVTTL-O	IntL	Interrupt
29		Vcc Tx	+3.3V Power supply transmitter
30		Vcc1	+3.3V Power supply
31	LVTTL-I	LPMODE	Low Power Mode
32		GND	Ground
33	CML-I	Tx3p	Transmitter Non-Inverted Data Input

34	CML-I	Tx3n	Transmitter Inverted Data Input
35		GND	Ground
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input
37	CML-I	Tx1n	Transmitter Inverted Data Input
38		GND	Ground



Top Side
Viewed From Top

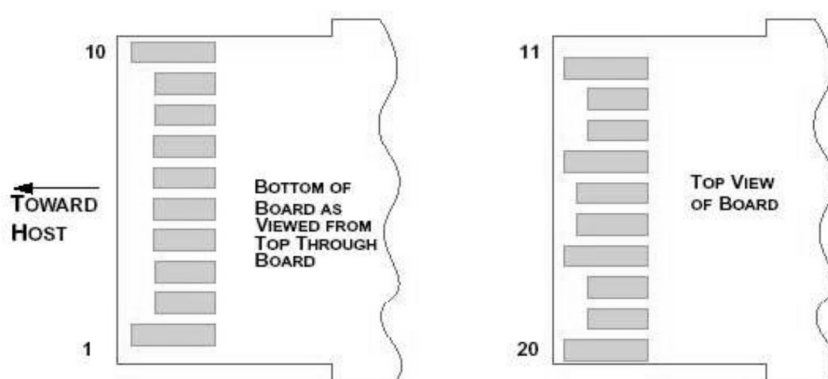
Module Card Edge



Bottom Side
Viewed From Bottom

SFP28 Pin Function Definition

Pin	Logic	Symbol	Description
1		VeeT	Module Transmitter Ground
2	LVTTL-O	Tx_Fault	Module Transmitter Fault
3	LVTTL-I	Tx_Disable	Transmitter disable; Turns off transmitter laser output
4	LVTTL-I/O	SDA	2-wire Serial Interface Data Line (Same as MOD-DEF2 in INF-8074i)
5	LVTTL-I/O	SCL	2-wire Serial Interface Clock (Same as MOD-DEF1 in INF-8074i)
6		Mod_ABS	Module Absent, connected to VeeT or VeeR in the module
7	LVTTL-I	RS0	Rate Select 0, optionally controls SFP+ module receiver
8	LVTTL-O	Rx_LOS	Receiver Loss of Signal Indication (In FC designated as Rx_LOS and in Ethernet designated as Signal Detect)
9	LVTTL-I	RS1	Rate Select 1, optionally controls SFP+ module transmitter
10		VeeR	Module Receiver Ground
11		VeeR	Module Receiver Ground
12	CML-O	RD-	Receiver Inverted Data Output
13	CML-O	RD+	Receiver Non-Inverted Data Output
14		VeeR	Module Receiver Ground
15		VccR	Module Receiver 3.3 V Supply
16		VccT	Module Transmitter 3.3 V Supply
17		VeeT	Module Transmitter Ground
18	CML-I	TD+	Transmitter Non-Inverted Data Input
19	CML-I	TD-	Transmitter Inverted Data Input
20		VeeT	Module Transmitter Ground



General Product Characteristics

QSFP28/4SFP28 DAC Specifications	
Number of Lanes	Tx4 Rx4(QSFP28) Tx1 Rx1(SFP28)
Channel Data Rate	28.3125Gbps
Operating Temperature	0 to + 70°C
Storage Temperature	-40 to + 85°C
Supply Voltage	3.3 V nominal
Electrical Interface	38pins edge connector(QSFP28) 20 pins edge connector(SFP28)
Management Interface	Serial, I ² C

High Speed Characteristics

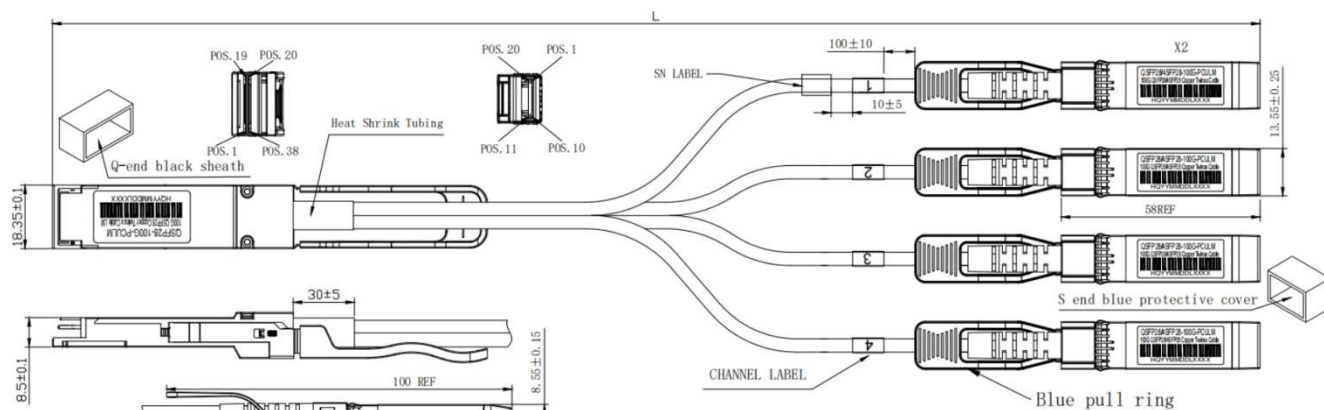
Parameter	Symbol	Min	Typical	Max	Unit	Note
Differential Impedance	TDR	90	100	110	Ω	
Insertion loss	SDD21	-22.48			dB	At 12.8906 GHz
Differential Return Loss	SDD11 SDD22			See 1	dB	At 0.05 to 4.1 GHz
				See 2	dB	At 4.1 to 19 GHz
Common-mode to common-mode output return loss				-2	dB	At 0.2 to 19 GHz
Differential to common-mode return loss	SCD11 SCD22			See 3	dB	At 0.01 to 12.89 GHz
				See 4		At 12.89 to 19 GHz
Differential to common Mode Conversion Loss	SCD21-IL			-10	dB	At 0.01 to 12.89 GHz
				See 5		At 12.89 to 15.7 GHz
				-6.3		At 15.7 to 19 GHz

Notes:

1. Reflection Coefficient given by equation $SDD11(dB) < -16.5 + 2 \times \sqrt{f}$, with f in GHz
2. Reflection Coefficient given by equation $SDD11(dB) < -10.66 + 14 \times \log_{10}(f/5.5)$, with f in GHz
3. Reflection Coefficient given by equation $SCD11(dB) < -22 + (20/25.78) \times f$, with f in GHz
4. Reflection Coefficient given by equation $SCD11(dB) < -15 + (6/25.78) \times f$, with f in GHz
5. Reflection Coefficient given by equation $SCD21(dB) < -27 + (29/22) \times f$, with f in GHz

Mechanical Specifications

The connector is compatible with the SFF8432 to SFF8436 specification.



Length (m)	Cable AWG
1	30
2	30
3	30/26
4	26
5	26

Regulatory Compliance

Feature	Test Method	Performance
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883C Method 3015.7	Class 1(>2000 Volts)
Electromagnetic Interference(EMI)	FCC Class B	Compliant with Standards
	CENELEC EN55022 Class B	
	CISPR22 ITE Class B	
RF Immunity(RFI)	IEC61000-4-3	Typically Show no Measurable Effect from a 10V/m Field Swept from 80 to 1000MHz
RoHS Compliance	RoHS Directive 2011/65/EU and it's Amendment Directives (EU) 2015/863	RoHS (EU) 2015/863 compliant
REACH Compliance	REACH Regulation (EC) No 1907/2006	REACH (EC) No 1907/2006 compliant